

MITSUBISHI TRANSISTOR MODULES

QM50TX-H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

QM50TX-H



- **I_c** Collector current **50A**
- **V_{CEx}** Collector-emitter voltage **600V**
- **h_{FE}** DC current gain **75**
- **Insulated Type**
- **UL Recognized**

Yellow Card No. E80276 (N)

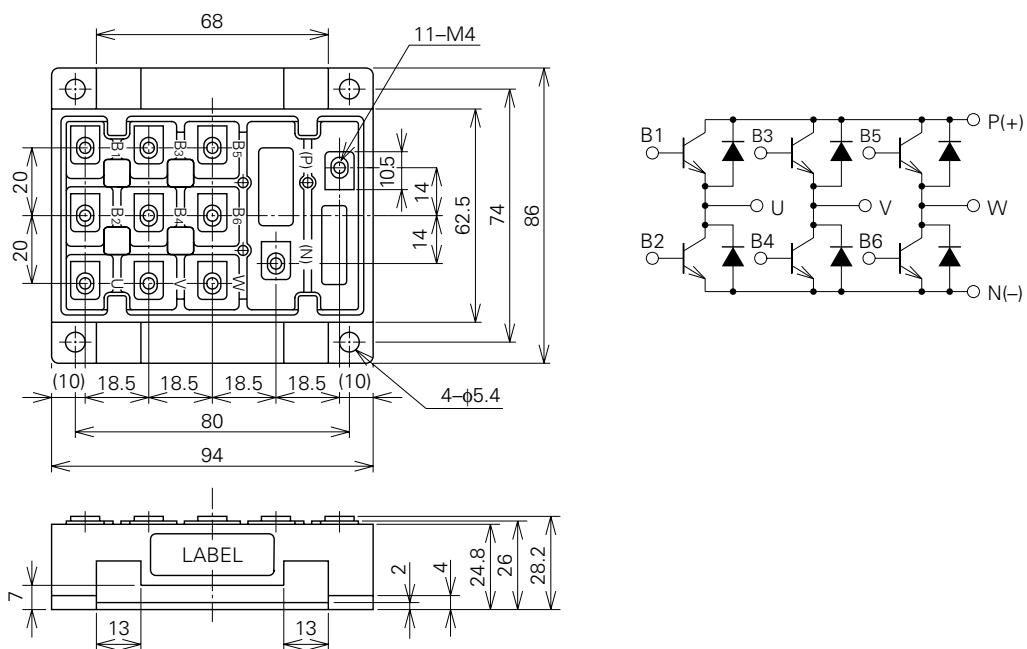
File No. E80271

APPLICATION

AC motor controllers, UPS, DC motor controllers, NC equipment, Welders

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



Note: All Transistor Units are Darlingtons.

Feb.1999

ABSOLUTE MAXIMUM RATINGS ($T_j=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Ratings	Unit
VCEX (SUS)	Collector-emitter voltage	$I_C=1\text{A}$, $V_{EB}=2\text{V}$	600	V
VCEX	Collector-emitter voltage	$V_{EB}=2\text{V}$	600	V
VCBO	Collector-base voltage	Emitter open	600	V
VEBO	Emitter-base voltage	Collector open	7	V
I_C	Collector current	DC	50	A
$-I_C$	Collector reverse current	DC (forward diode current)	50	A
Pc	Collector dissipation	$T_c=25^\circ\text{C}$	310	W
I_B	Base current	DC	3	A
$-I_{CSM}$	Surge collector reverse current (forward diode current)	Peak value of one cycle of 60Hz (half wave)	500	A
T_j	Junction temperature		-40~+150	$^\circ\text{C}$
Tstg	Storage temperature		-40~+125	$^\circ\text{C}$
Viso	Isolation voltage	Charged part to case, AC for 1 minute	2500	V
—	Mounting torque	Main terminal screw M4	0.98~1.47	N·m
			10~15	kg·cm
		Mounting screw M5	1.47~1.96	N·m
			15~20	kg·cm
—	Weight	Typical value	520	g

ELECTRICAL CHARACTERISTICS ($T_j=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
I_{CEX}	Collector cutoff current	$V_{CE}=600\text{V}$, $V_{EB}=2\text{V}$	—	—	1.0	mA
I_{CBO}	Collector cutoff current	$V_{CB}=600\text{V}$, Emitter open	—	—	1.0	mA
I_{EBO}	Emitter cutoff current	$V_{EB}=7\text{V}$	—	—	200	mA
$V_{CE}(\text{sat})$	Collector-emitter saturation voltage	$I_C=50\text{A}$, $I_B=0.65\text{A}$	—	—	2.0	V
$V_{BE}(\text{sat})$	Base-emitter saturation voltage		—	—	2.5	V
$-V_{CEO}$	Collector-emitter reverse voltage	$-I_C=50\text{A}$ (diode forward voltage)	—	—	1.75	V
hFE	DC current gain	$I_C=50\text{A}$, $V_{CE}=2\text{V}/5\text{V}$	75/100	—	—	—
t_{on}	Switching time	$V_{CC}=300\text{V}$, $I_C=50\text{A}$, $I_{B1}=-I_{B2}=1\text{A}$	—	—	1.5	μs
t_s			—	—	12	μs
t_f			—	—	3.0	μs
$R_{th(j-c)Q}$	Thermal resistance (junction to case)	Transistor part (per 1/6 module)	—	—	0.4	$^\circ\text{C}/\text{W}$
$R_{th(j-c)R}$		Diode part (per 1/6 module)	—	—	1.3	$^\circ\text{C}/\text{W}$
$R_{th(c-f)}$	Contact thermal resistance (case to fin)	Conductive grease applied (per 1/6 module)	—	—	0.2	$^\circ\text{C}/\text{W}$